Features

• Ideal for indication light on hand held products

www.SunLEDusa.com

• Long life and robust package

• Variety of lens types and color choices available

ullet Package : 2000pcs / reel

• Moisture sensitivity level : level 3

• RoHS compliant

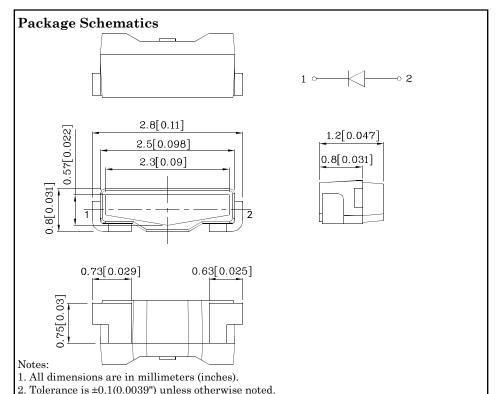






ATTENTION OBSERVE PRECAUTIONS FOR HANDLING ELECTROSTATIC DISCHARGE SENSITIVE

DEVICES



Absolute Maximum Ratings DG Unit $(T_A=25^{\circ}C)$ (InGaN) Reverse Voltage $V_{\rm R}$ 5 V Forward Current $I_{\rm F}$ 25 mA Forward Current (Peak) 1/10 Duty Cycle 150 mA i_{FS} 0.1ms Pulse Width P_{D} mWPower Dissipation 102.5 $T_{\boldsymbol{A}}$ Operating Temperature -40 ~ +85 °C Tstg -40 ~ +85 Storage Temperature Electrostatic Discharge Threshold V 450 (HBM)

Operating Characteristics $(T_A=25^{\circ}C)$		DG (InGaN)	Unit
Forward Voltage (Typ.) (I _F =20mA)	V_{F}	3.3	V
Forward Voltage (Max.) (I _F =20mA)	V_{F}	4.1	V
Reverse Current (Max.) $(V_R=5V)$	I_R	50	uA
Wavelength of Peak Emission (Typ.) (I _F =20mA)	λΡ	515	nm
Wavelength of Dominant Emission (Typ.) $(I_F=20\text{mA})$	λD	525	nm
Spectral Line Full Width At Half-Maximum (Typ.) (I _F =20mA)	$\triangle \lambda$	30	nm
Capacitance (Typ.) (V _F =0V, f=1MHz)	С	45	pF

Part Number	Emitting Color	Emitting Material	Lens-color	$\begin{array}{c} \text{Luminous} \\ \text{Intensity} \\ \text{(I}_{\text{F}}\text{=}20\text{mA}) \\ \text{mcd} \end{array}$		Wavelength nm λΡ	Viewing Angle 20 1/2
				min.	typ.		
XZDG81FS	Green	InGaN	Water Clear	400	695	515	110°

3. Specifications are subject to change without notice.

Apr 14,2011 XDSB3988 V2 Layout: Maggie L.





Handling Precautions

 $Compare \ to \ epoxy \ encapsulant \ that \ is \ hard \ and \ brittle, \ silicone \ is \ softer \ and \ flexible. \ Although \ its \ characteristic \ significantly \ reduces \ thermal \ stress, \ it \ is \ more \ susceptible \ to \ damage \ by \ external \ mechanical \ force.$

As a result, special handling precautions need to be observed during assembly using silicone encapsulated LED products. Failure to comply might lead to damage and premature failure of the LED.

1.Do not directly touch or handle the silicone lens surface. It may damage the internal circuitry.

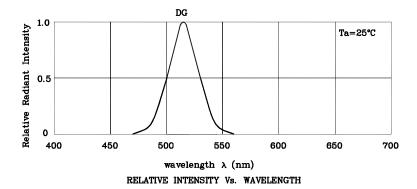


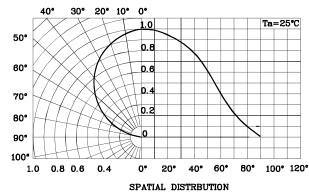
2. As silicone encapsulation is permeable to gases, some corrosive substances such as H_2S might corrode silver plating of leadframe. Special care should be taken if an LED with silicone encapsulation is to be used near such substances.

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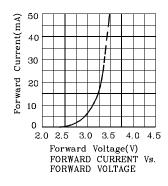


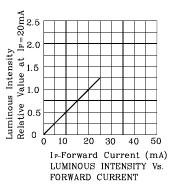


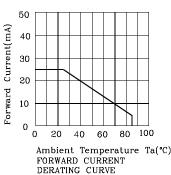


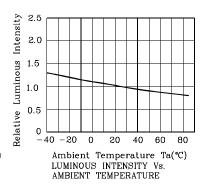


♦ DG



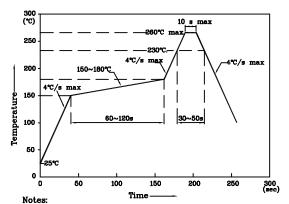






LED is recommended for reflow soldering and soldering profile is shown below.

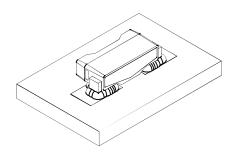
Reflow Soldering Profile for SMD Products (Pb-Free Components)



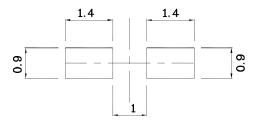
- 1. Maximum soldering temperature should not exceed 260°C
- 2. Recommended reflow temperature: 145°C-260°C
- 3. Do not put stress to the epoxy resin during high temperatures conditions



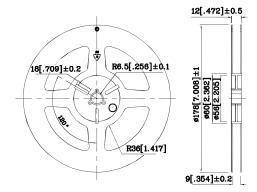
❖ The device has a single mounting surface. The device must be mounted according to the specifications.



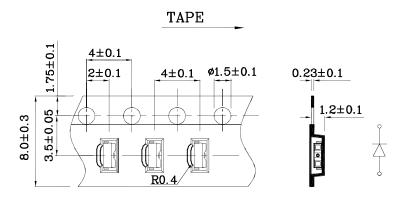
♦ Recommended Soldering Pattern (Units: mm; Tolerance: ± 0.1)



* Reel Dimension



❖ Tape Specification (Units:mm)



Remarks:

If special sorting is required (e.g. binning based on forward voltage, Luminous intensity / luminous flux, or wavelength), the typical accuracy of the sorting process is as follows:

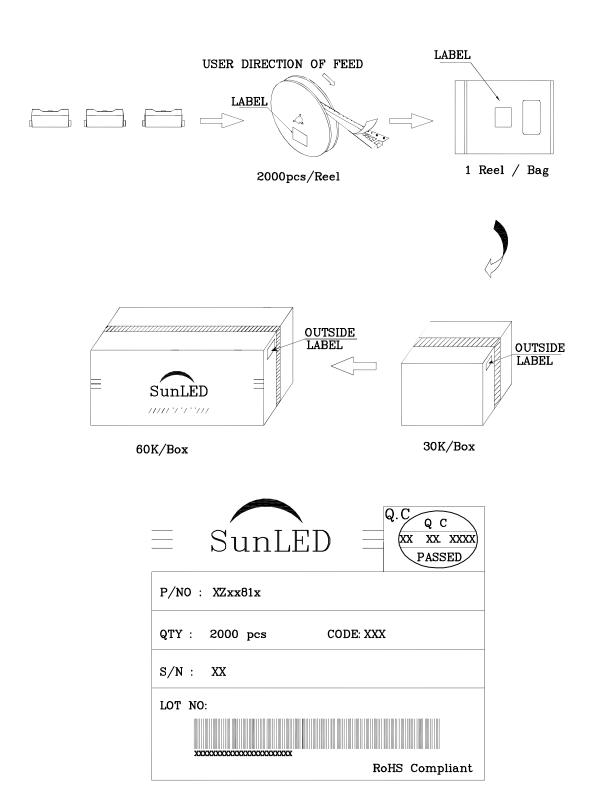
- 1. Wavelength: +/-1nm
- 2. Luminous intensity / luminous flux: +/-15%
- 3. Forward Voltage: +/-0.1V

Note: Accuracy may depend on the sorting parameters.

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PACKING & LABEL SPECIFICATIONS



Apr 14,2011